

REV./ECN NO.	LOCATIONS	DESCRIPTION	DATE	CHANGER

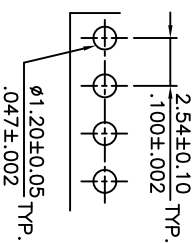
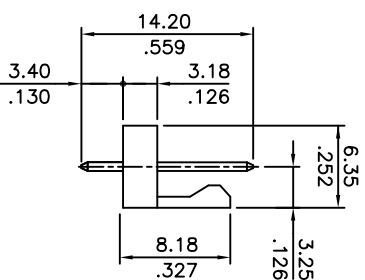
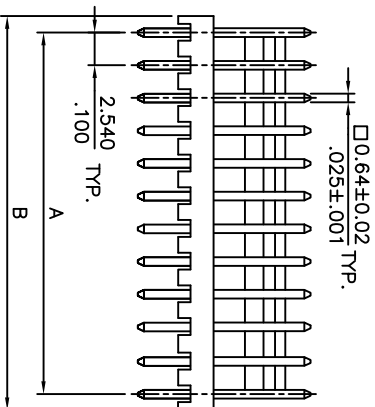
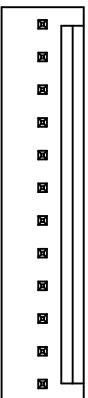
Ordering Code:

TS247- X X 0 0
 ① ② ③ ④

- ① Series No.
- ② No. of Circuits

- ③ Plating option:

T = 3.05µm(120µ") Min. Tin
 over 0.76µm(30µ") Nickel
 ④ Type: 0= Straight , Low Profile



Circuits	Dimension	
	A	B
2	2.54(.100)	5.1(.200)
3	5.08(.200)	7.7(.303)
4	7.62(.300)	10.2(.400)
5	10.16(.400)	12.8(.504)
6	12.70(.500)	15.2(.600)
7	15.24(.600)	17.9(.700)
8	17.78(.700)	20.4(.803)
9	20.32(.800)	23.0(.906)
10	22.86(.900)	25.5(1.003)
11	25.40(1.000)	28.1(1.098)
12	27.94(1.100)	30.6(1.205)

Material:

- * Insulation: Nylon 66 UL 94V-0
- * Contact: Brass

Recommended P.C. Board Layout

GENERAL TOLERANCE		鉅創科技有限公司 TRONTEK TECHNOLOGY CO., LTD. TITLE: WAFER 2.54mm(1.0") STRAIGHT
X±	X±.1*	
X± 0.30	X*±	
XX± 0.20	XX*±	
XXX± 0.10	XXX*±	
CUSTOMER DRAWING		PART NO. TS247WV-XXXX
APPROVED Kevin		DWG. NO. 20120617
CHECKED: Paul		SCALE: 1:1
DRAWN: Frank		SHEET: 1 / 1
M/M		A